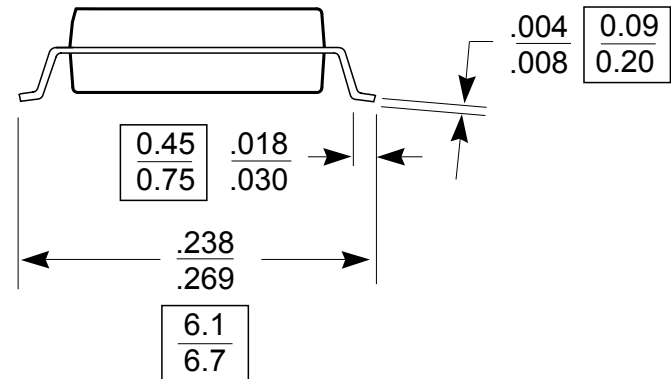
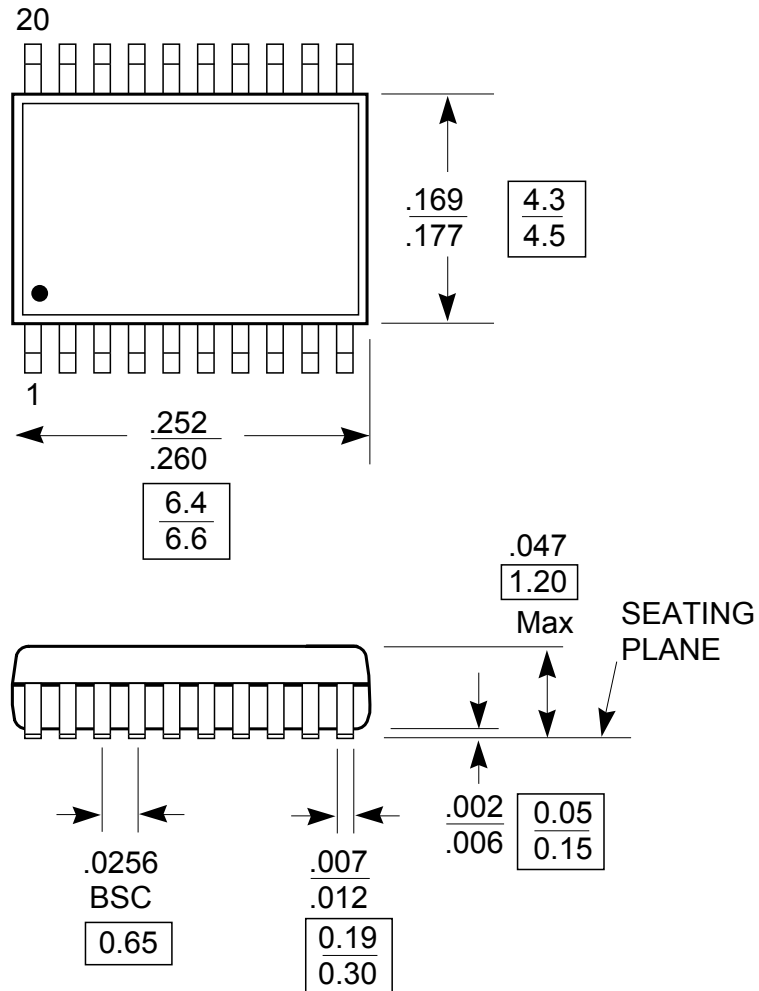


DOCUMENT CONTROL NO.
PD - 1311

REVISION: E
DATE: 03/09/05



Note:

1. Package Outline Exclusive of Mold Flash and Metal Burr
2. Controlling dimensions in millimeters
3. Ref: JEDEC MO-153F/AC



Pericom Semiconductor Corporation
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DESCRIPTION: 20-Pin, 173-Mil Wide, TSSOP

PACKAGE CODE: L